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Part Number: [0753417474](#)
Status: **Active**
Overview: [gbx_backplane_connector_system](#)
Description: 1.85mm by 1.85mm (.073 by .073") Pitch 4-Pair GbX® Backplane Connector System, Power Module, 12 Circuits, 1.27µm (50µ") Gold (Au)

Documents:
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Product Specification PS-75221-999 \(PDF\)](#)

Agency Certification

UL E29179

General

Product Family Backplane Connectors
Series [75341](#)
Application Backplane
Application Tooling Documents Tooling Manual
Comments Blade Length A 7.50mm, B 4.50mm, C 7.50mm, D 4.50mm
Component Type Power Header
Overview [gbx_backplane_connector_system](#)
Product Name GbX®
Style N/A

Physical

Circuits (Loaded) 8
Circuits (maximum) 8
Circuits Detail Rows A, B, C, & D
Color - Resin Gray
Durability (mating cycles max) 200
First Mate / Last Break Yes
Flammability 94V-0
Guide to Mating Part No
Keying to Mating Part None
Material - Plating Mating Gold
Material - Plating Termination Tin-Lead
Material - Resin High Temperature Thermoplastic
Number of Columns N/A
Number of Pairs 4
Number of Rows 4
Orientation Vertical
PC Tail Length (in) 0.089 In
PC Tail Length (mm) 2.28 mm
PCB Locator Yes
PCB Retention Yes
PCB Thickness Recommended (in) 0.063 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tube
Pitch - Mating Interface (in) 0.073 In
Pitch - Mating Interface (mm) 1.85 mm
Pitch - Term. Interface (in) 0.102 In
Pitch - Term. Interface (mm) 2.60 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25



Series

image - Reference only

EU RoHS
RoHS Compliant by Exemption
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS

Pb

Need more information on product environmental compliance?
Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)
Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[75341Series](#)

Mates With
[75292 GbX® Daughtercard](#)

Application Tooling | FAQ
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
Insertion Module, GbX® 4 pair 1- Up Power Module	0622022005
GbX® Single Pin Repair Tool	0622022090
GbX® Shield Removal Tool	0622022100

Plating min: Termination (μin)	30
Plating min: Termination (μm)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Real Signals (per 25mm)	0
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Product Specification	PS-75221-999
Sales Drawing	SD-75341-001

GbX is a registered trademark of Amphenol Corporation.

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- NOTES:
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, GRAY; CONTACT - COPPER ALLOY.
 2. FINISH: SELECT GOLD IN CONTACT AREA, 50 μ " THICK; TIN/LEAD OR MATTE TIN IN COMPLIANT AREA.
 3. PACKAGING PER PK-70873-562.
 4. CONTACTS IN EACH ROW HAVE THE SAME WIPE LENGTH.
 5. BACKPLANE ASSEMBLY MATES WITH DAUGHTERCARD POWER MODULE 75292-4***.
 6. PART SHOWN IS 75343-4467 (SHEET 4).
 7. SEE OTHER SHEETS FOR ADDITIONAL NOTES.
 8. WHEN INSERTING OPEN SIGNAL MODULES NEXT TO COLUMN 1 SIDE OF POWER MODULES, SIGNAL MODULES MUST BE INSERTED BEFORE THE POWERS TO AVOID INTERFERENCE BETWEEN THE TWO CONNECTOR HOUSINGS.
 9. THESE PARTS CONFORM TO MOLEX PRODUCT SPECIFICATION PS-75221-999.
 10. THESE PARTS CONFORM TO MOLEX COSMETIC SPECIFICATION PS-45499-002 CLASS B.

ADDED NOTES 9 & 10 EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J.B. INGHAM 2007/08/31				QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		mm	INCH		DRAWN BY	DATE	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX MOLEX INCORPORATED					
		4 PLACES ± ---	± ---		ELO	2006/04/06						
		3 PLACES ± ---	± ---		CHECKED BY	DATE						
		2 PLACES ± ---	± ---	ELO	2005/02/22							
		1 PLACE ± ---	± ---	APPROVED BY	DATE							
		ANGULAR ± ---°		CUNNINGHAM	2005/02/23							
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.					SHEET NO.	
				SEE CHART		SD-75341-001					1 OF 4	
				SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

10 9 8 7 6 5 4 3 2 1



2-UP ASSEMBLY PART NUMBER

7 5 3 4 2 - A B C D

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE



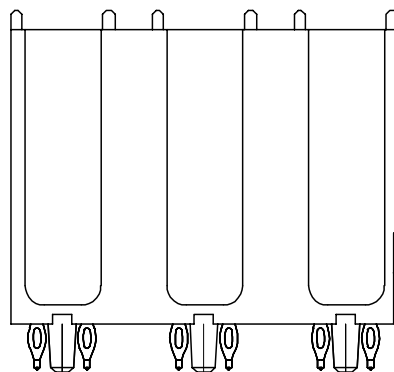
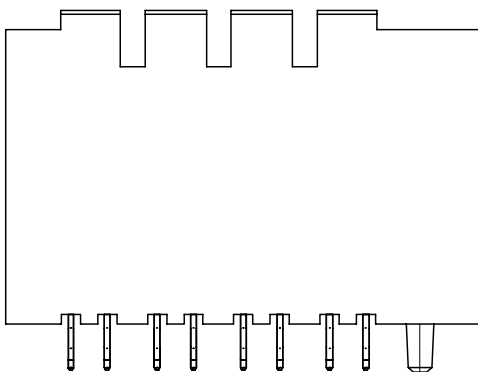
SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: J. B. INGHAM 2007/08/30 APPR: J. B. INGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)				DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm		INCH		DRAWN BY ELO	DATE 2006/04/06	GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED				
			4 PLACES	± ---	± ---	CHECKED BY ELO	DATE 2005/02/22						
			3 PLACES	± ---	± ---	APPROVED BY CUNNINGHAM	DATE 2005/02/23						
			2 PLACES	± ---	± ---	MATERIAL NO.	DOCUMENT NO.						
			1 PLACE	± ---	± ---	ANGULAR ± ---°		SEE CHART		SD-75341-001		SHEET NO. 2 OF 4	
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



COLUMN 1
COLUMN 2
COLUMN 3
COLUMN 4
COLUMN 5
COLUMN 6

SEE NOTE 4.



SEE NOTE 8.

3-UP ASSEMBLY PART NUMBER

7 5 3 4 3 - A B C D

- TIN/LEAD PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

4 = 4.5 mm WIPE

6 = 6.0 mm WIPE

7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

2 = 4.5 mm WIPE

3 = 6.0 mm WIPE

5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: JB INGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED	
			4 PLACES	± ---	± ---	CHECKED BY	DATE		
			3 PLACES	± ---	± ---	ELO	2005/02/22		
			2 PLACES	± ---	± ---	APPROVED BY	DATE		
			1 PLACE	± ---	± ---	CUNN INGHAM	2005/02/23		
			ANGULAR ± ---°		MATERIAL NO.	DOCUMENT NO.	SHEET NO.		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-75341-001	3 OF 4	
					SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			



SEE NOTE 5.

6.0 mm WIPE
7.5 mm WIPE
4.5 mm WIPE

0.76
DC BOARD EDGE TO
CENTERLINE OF BP TAIL

0.15

HOLE PATTERN FOR 1-UP ASSEMBLY

- 1.) ADD 7.40 FROM CENTERLINES OF PEGS FOR MULTIPLE UP ASSEMBLIES.
- 2.) ADD 5.55 FROM CENTERLINE TO CENTERLINE OF PEG FOR INDIVIDUAL POWER MODULES STACKED NEXT TO EACH OTHER.



ADDED $\phi 0.74 \pm 0.06$ EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J. BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
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		4 PLACES	± ---	± ---	CHECKED BY ELO	DATE 2005/02/22					
		3 PLACES	± ---	± ---	APPROVED BY CUNNINGHAM		DATE 2005/02/23	MOLEX MOLEX INCORPORATED			
		2 PLACES	± ---	± ---							
1 PLACE	± ---	± ---	ANGULAR ± ---°		MATERIAL NO.	DOCUMENT NO.	SHEET NO. 4 OF 4				
REV C	DESCRIPTION	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE PREVIOUS		SD-75341-001					
				SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.